

3.0x1.0mm RIGHT ANGLE SMD CHIP LED **LAMP**



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE **SENSITIVE DEVICES**

Part Number: APFA3010SEEZGQBDC

Hyper Red Green Blue

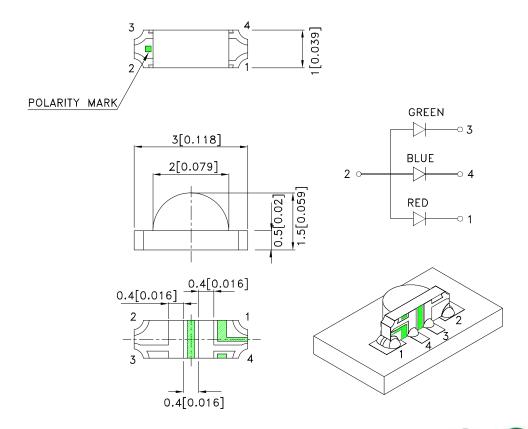
Features

- 3.0mmx1.0mm right angle SMT LED, 1.5mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Descriptions

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.
- The Blue source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		,,	Min.	Тур.	201/2
APFA3010SEEZGQBDC	Hyper Red (AlGalnP)		80	140	120°
	Green (InGaN)	Water Clear	200	300	
	Blue (InGaN)		40	70	

Notes:

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
 Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green Blue	630 515 460		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red Green Blue	621 525 465		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green Blue	20 30 25		nm	IF=20mA
С	Capacitance	Hyper Red Green Blue	25 45 100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green Blue	2 3.3 3.3	2.5 4.1 4	V	IF=20mA
lr	Reverse Current	Hyper Red Green Blue		10 50 50	uA	V _R =5V

Notes:

- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

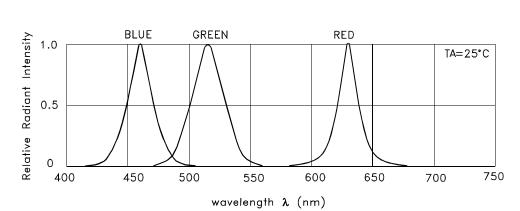
Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Green	Blue	Units		
Power dissipation	75	102.5	120	mW		
DC Forward Current	30	25	30	mA		
Peak Forward Current [1]	195	150	150	mA		
Reverse Voltage	5 V					
Operating Temperature	-40°C To +85°C					
Storage Temperature	-40°C To +85°C					

Notes:

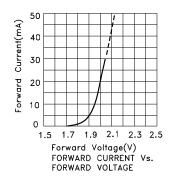
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

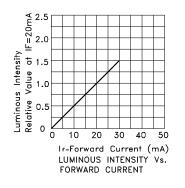
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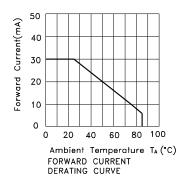


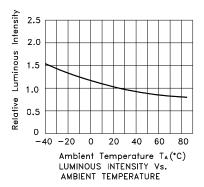
RELATIVE INTENSITY Vs. WAVELENGTH

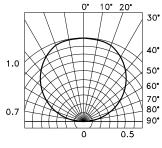
APFA3010SEEZGQBDC Hyper Red









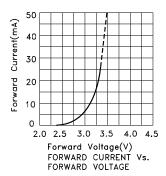


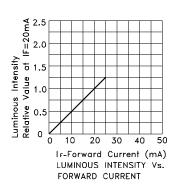
SPATIAL DISTRIBUTION

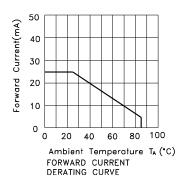
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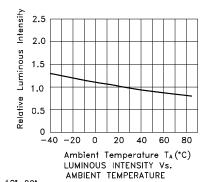
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Green



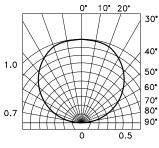






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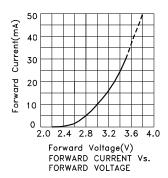


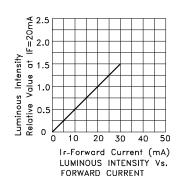
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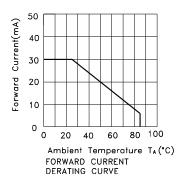
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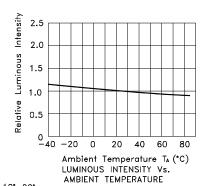
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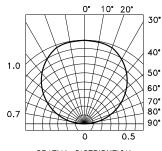
Blue











SPATIAL DISTRIBUTION

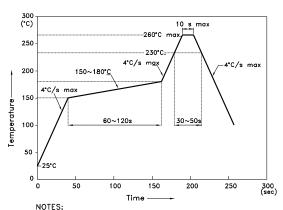
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



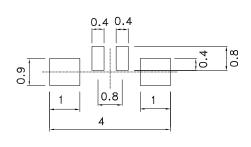
- NOTES:

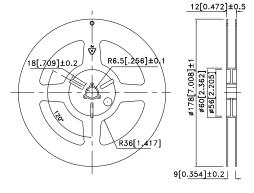
 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

Reel Dimension





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Tape Dimensions (Units: mm)

TAPE

4.0±0.1
4.0±0.1
4.0±0.1

2.0±0.05

2.0±0.05

3 4 1

1.25±0.1

3 4 1

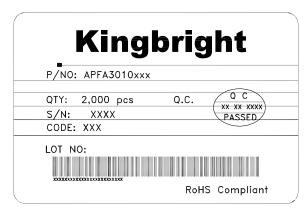
1.87±0.1

A-A SECTION

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PACKING & LABEL SPECIFICATIONS APFA3010SEEZGQBDC USER DIRECTION OF FEED LABEL 2,000pcs / Reel 1 Reel / Bag OUTSIDE LABEL Kingbright Kingbright LABEL OUTSIDE LABEL Kingbright



30K / 55# Box

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